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| <p>Form PTO-1449 (modified) List of Patents and Publications For Application Information Disclosure Statement (Use several sheets if necessary)</p> | <p>ATTY. DKT. NO. 5732-00100</p> <p>APPLICANT: Chhor et al.</p> <p>FILING DATE: August 13, 2001</p> | <p>SERIAL NO. 09/928,767</p> <p>GROUP: 2818</p> |
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U.S. PATENT DOCUMENTS

| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
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| | A2 | 3,432,827 | 3/1969 | Sarno | | | |
| | A3 | 4,489,478 | 12/1984 | Sakurai | | | |
| | A4 | 4,500,905 | 2/1985 | Shibata | | | |
| | A5 | 4,535,424 | 8/1985 | Reid | | | |
| | A6 | 4,630,096 | 12/1986 | Drye et al. | | | |
| | A7 | 4,672,577 | 6/1987 | Hirose et al. | | | |
| | A8 | 4,710,798 | 12/1987 | Marcantonio | | | |
| | A9 | 4,811,082 | 3/1989 | Jacobs et al. | | | |
| | A10 | 5,001,539 | 3/1991 | Inoue et al. | | | |
| | A11 | 5,089,862 | 2/1992 | Warner, Jr. et al. | | | |
| | A12 | 5,160,987 | 11/1992 | Pricer et al. | | | |
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| | A15 | 5,227,338 | 7/1993 | Kryzaniwsky | | | |
| | A16 | 5,266,912 | 11/1993 | Kledzik | | | |
| | A17 | 5,283,468 | 2/1994 | Kondo et al. | | | |
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| | A19 | 5,422,435 | 6/1995 | Takiar et al. | | | |
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| | A21 | 5,434,745 | 7/1995 | Shokrgozar et al. | | | |
| | A22 | 5,453,952 | 9/1995 | Okudaira et al. | | | |
| | A23 | 5,455,445 | 10/1995 | Kurtz et al. | | | |
| | A24 | 5,468,997 | 11/1995 | Imai et al. | | | |
| | A25 | 5,481,090 | 1/1996 | Senock et al. | | | |
| | A26 | 5,481,133 | 1/1996 | Hsu | | | |
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| Form PTO-1449 (modified) List of Patents and Publications For Applicant's Information Disclosure Statement (Use several sheets if necessary) | | | ATTY. DKT. NO. 5732-00100 APPLICANT: Chhor et al. FILING DATE: August 13, 2001 | | SERIAL NO. 09/928,767 GROUP: 2818 | | |
|---|--------------|-----------------|--|---------------------|--|--------------|-------------------------------|
| U.S. PATENT DOCUMENTS | | | | | | | |
| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
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| | A29 | 5,523,622 | 6/1996 | Harada et al. | | | |
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| | A31 | 5,552,963 | 9/1996 | Burns | | | |
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| | A35 | 5,612,570 | 3/1997 | Eide et al. | | | |
| | A36 | 5,654,220 | 8/1997 | Leedy | | | |
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| | A51 | 6,072,234 | 6/2000 | Camien et al. | | | |
| | A52 | 6,085,412 | 7/2000 | Iwasaki | | | |
| | A53 | 6,087,722 | 7/2000 | Lee et al. | | | |
| LT | A54 | 6,108,730 | 8/2000 | Dell et al. | | | |

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| U.S. PATENT DOCUMENTS | | | | | | | |
| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
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| LT | A69 | 2001/0033030 | 10/2001 | Leedy | | | |
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| | A71 | 2002/0024146 | 2/2002 | Furusawa | | | |
| | A72 | 2002/0027275 | 3/2002 | Fujimoto et al. | | | |
| | A73 | 2002/0030262 | 3/2002 | Akram | | | |
| LT | A74 | 2002/0030263 | 3/2002 | Akram | | | |
| FOREIGN PATENT DOCUMENTS | | | | | | | |
| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUB CLASS | TRANSLATION YES/NO |
| LT | A75 | 0 073 486 | 3/1983 | EP | | | |
| LT | A76 | 0 387 834 | 9/1990 | EP | | | |

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| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUB CLASS | TRANSLATION YES/NO |
| LT | A77 | 0 395 886 | 11/1990 | EP | | | |
| | A78 | 0 516 866 | 12/1992 | EP | | | Yes, Abstract Only |
| | A79 | 0 606 653 | 7/1994 | EP | | | |
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| | A111 | Tielert, "Benefits of Vertically Stacked Integrated Circuits for Sequential Logic," © 1996 IEEE, pp. 121-124. | |
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| | A115 | "Stacked Memory Modules," IBM Technical Disclosure Bulletin, Vol. 38, No. 5, 1995, 2 pgs. | |
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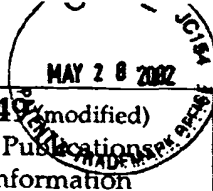
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Form PTO-1449 (modified)
 List of Patents and Publications
 For Applicant's Information
 Disclosure Statement
 (Use several sheets if necessary)

ATTY. DKT. NO. 5732-00300
 APPLICANT: Verma et al.
 FILING DATE: February 19, 2002

SERIAL NO. 10/080,036
 GROUP: 2185

U.S. PATENT DOCUMENTS

| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
|----------------|-----------|-----------------|---------|--------------|-------|-----------|----------------------------|
| LT | B1 | Re. 36,229 | 6/1999 | Cady | | | |
| | B2 | 5,221,642 | 6/1993 | Burns | | | |
| | B3 | 5,236,117 | 8/1993 | Roane et al. | | | |
| | B4 | 5,279,029 | 1/1994 | Burns | | | |
| | B5 | 5,367,766 | 11/1994 | Burns et al. | | | |
| | B6 | 5,369,056 | 11/1994 | Burns et al. | | | |
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| | B8 | 5,371,866 | 12/1994 | Cady | | | |
| | B9 | 5,377,077 | 12/1994 | Burns | | | |
| | B10 | 5,420,751 | 5/1995 | Burns | | | |
| | B11 | 5,446,620 | 8/1995 | Burns et al. | | | |
| | B12 | 5,448,450 | 9/1995 | Burns | | | |
| | B13 | 5,455,740 | 10/1995 | Burns | | | |
| | B14 | 5,479,318 | 12/1995 | Burns | | | |
| | B15 | 5,484,959 | 1/1996 | Burns | | | |
| | B16 | 5,493,476 | 2/1996 | Burns | | | |
| | B17 | 5,498,906 | 3/1996 | Roane et al. | | | |
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| | B19 | 5,528,075 | 6/1996 | Burns | | | |
| | B20 | 5,543,664 | 8/1996 | Burns | | | |
| | B21 | 5,550,711 | 8/1996 | Burns et al. | | | |
| | B22 | 5,552,963 | 9/1996 | Burns | | | |
| | B23 | 5,561,591 | 10/1996 | Burns | | | |
| | B24 | 5,566,051 | 10/1996 | Burns | | | |
| | B25 | 5,572,065 | 11/1996 | Burns | | | |
| | B26 | 5,581,121 | 12/1996 | Burns et al. | | | |
| LT | B27 | 5,585,668 | 12/1996 | Burns | | | |

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|---|-----------|--|---------|--|-------|-----------|----------------------------|
| U.S. PATENT DOCUMENTS | | | | | | | |
| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
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| | B31 | 5,605,592 | 2/1997 | Burns | | | |
| | B32 | 5,615,475 | 4/1997 | Burns | | | |
| | B33 | 5,631,193 | 5/1997 | Burns | | | |
| | B34 | 5,644,161 | 7/1997 | Burns | | | |
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